N-Channel 60V, 1.7Ω Typ. Power MOSFET

Description

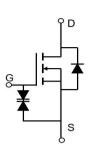
Features

• 60V, 0.2A

$$R_{DS(ON)}$$
Typ = 1.7 Ω @ V_{GS} = 10 V

$$R_{DS(ON)}$$
Typ = 2Ω @ V_{GS} = $4.5V$

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- Lead Free
- ESD Protected: 2KV





Application

- Load Switch
- PWM Application
- Power Management







Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMDTL2N7002K	72K	DFN1006-3L	TAPING	7"	10000	400000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		60	V
V_{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _A = 25°C	0.2	А
I _D	Continuous Drain Current	T _A = 100°C	0.12	А
I _{DM}	Pulsed Drain Current (1)		0.8	Α
P_{D}	Power Dissipation	T _A = 25°C	0.15	W
$R_{\scriptscriptstyle{\thetaJA}}$	Thermal Resistance, Junction to 0	Case ⁽²⁾	835	°C/W
T_J,T_STG	Junction & Storage Temperature	Range	-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
•	acteristics			J.		
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60V, V _{GS} = 0V	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±10	μА
On Char	acteristics				G	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.6	2.0	V
		$V_{GS} = 10V, I_D = 0.2A$	-	1.7	2.1	Ω
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 4.5V, I_D = 0.1A$	-	2.0	2.4	Ω
Dynamic	Characteristics					
C _{iss}	Input Capacitance			28	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	Χ-\	11	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11VII 12		4	-	pF
Q_g	Total Gate Charge		9 -	1.7	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 10V, I_{D} = 0.2A$	-	0.3	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} = 10 V, 1 _D = 0.27	-	0.6	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime	.rO	-	2	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 10V$	-	15	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	$I_D = 0.2A, R_{GEN} = 10\Omega$	-	7	-	ns
t_{f}	Turn-Off Fall Time			20	_	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I _S	Maximum Continuous Drain to Source D	iode Forward Current	-	-	0.2	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	0.8	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 0.2A$	-	_	1.2	V

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} R_{BJA} is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

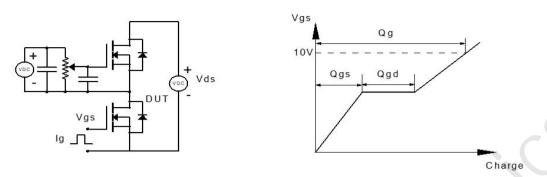


Figure 1: Gate Charge Test Circuit & Waveform

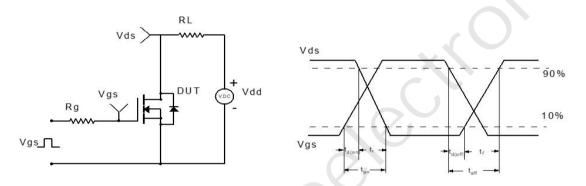


Figure 2: Resistive Switching Test Circuit & Waveform

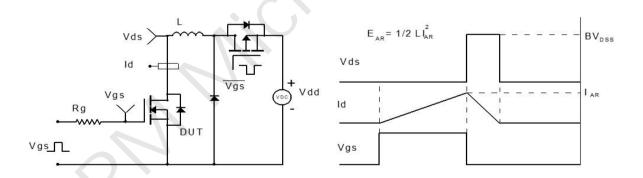


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

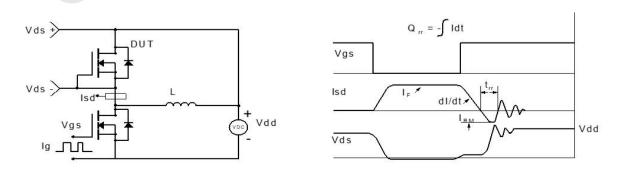
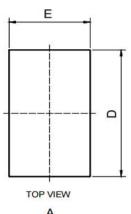
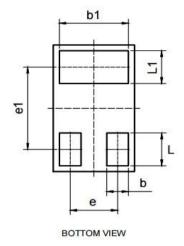


Figure 4: Diode Recovery Test Circuit & Waveform

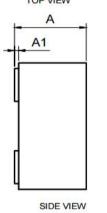
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Package Mechanical Data(DFN1006-3L)





SYMBOL	MIN	NOM	MAX
Α	0.45	0.50	0.55
A1	0.00	NA	0.03
L	0.22	0.26	0.30
b	0.12	0.16	0.20
D	0.95	1.00	1.05
E	0.55	0.60	0.65
L1	0.22	0.26	0.30
b1	0.47	0.51	0.55
е	0.35 BSC		
e1	0.65 BSC		



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